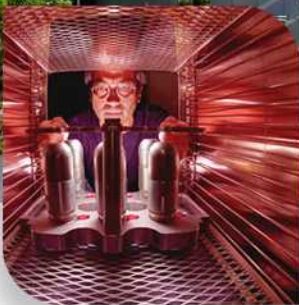




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Exceptional Service in  
the National Interest

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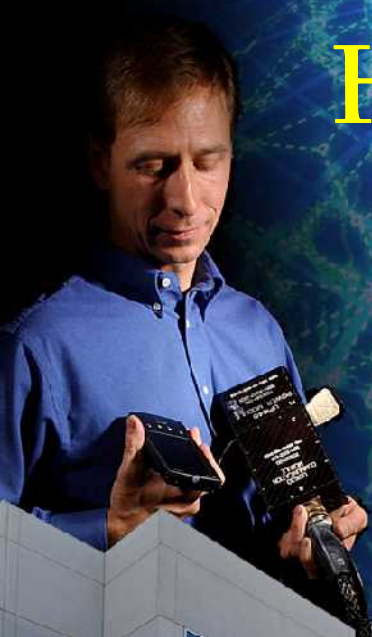
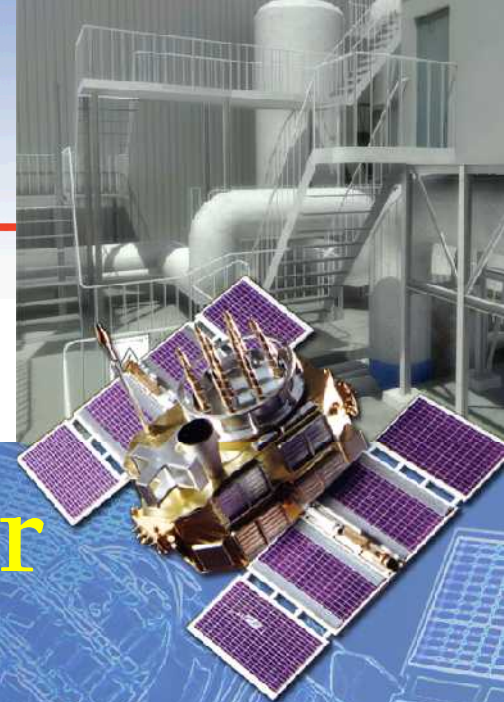
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# Hardware Analysis for Embedded Systems

Nathan Edwards

Embedded Systems Analysis Group

[njedwar@sandia.gov](mailto:njedwar@sandia.gov)



SAND #: XXXXX



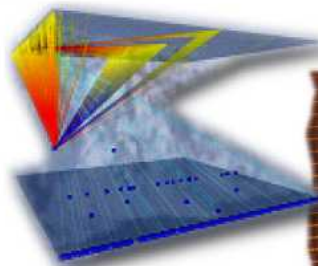
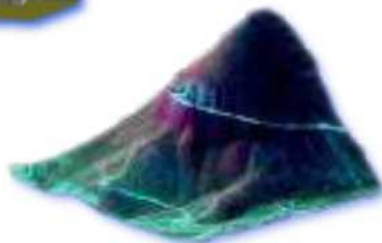
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# Homeland Security and Defense: Exploring Solutions Across the Threat Spectrum

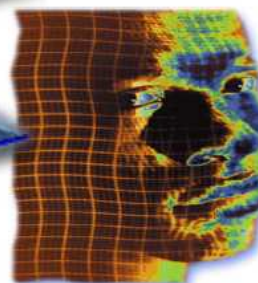


Synthetic Aperture  
Radars

Vulnerability  
Assessment  
Mod/Sim Tools



Cyber Security



Scanner-less  
Range  
Imager



Explosive  
Destruction System

Anticipate

Predict & Prevent

Respond

Recover

Access Delay



Critical Infrastructure  
Protection Systems  
Analysis Tools



Explosive Detection  
Portal

Unattended  
Ground Sensors



Radiation  
Remediation Foam

Tunnel  
Characterization



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# About Myself

- **BS Computer System Engineering**
  - Arizona State University, December 2009.
  
- **1995 - 1997, Mechanical Engineering Study**
- **1996 - 2005, Firefighter / Paramedic**
- **2006 - 2007, Medtronic Physio-Control, Technical Services**
- **2007 - 2008, Medtronic Microelectronics Center, HW Testing**
- **2008, Salt River Project, IT Help Desk**
- **2008 - 2010, Boeing IDS – Mesa, Real-Time SW Engineer**
- **2010 – Present, Sandia National Laboratories**





# What About You?

**What are some of your engineering areas of interest?**





# Importance of Embedded Devices

- **Infrastructure - Power Grid, Telecom Networks, Petroleum, NG**
  - Electrical relays, switches, valves, safety systems.
- **Vehicle Control Systems (air, water, land, etc.)**
  - Safety-critical control systems.
- **Industrial Automation & Control**
  - Manufacturing environments.
  - Home Automation and Control, Edge-system Smart Grid devices.
- **Personal Devices**
  - GPS, iPod, Accelerometers, Cell phones, etc.

**All Modern Technologies are Driven by Embedded Devices!**



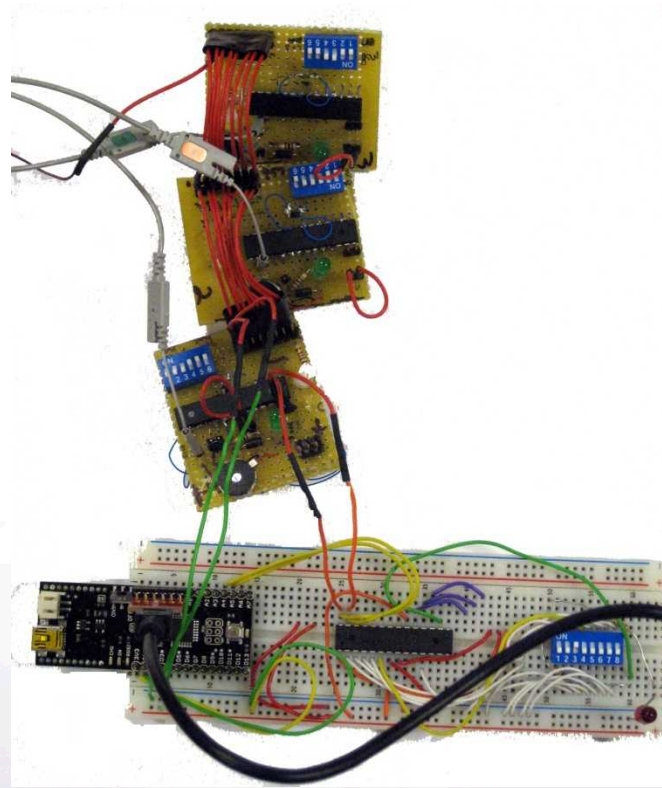
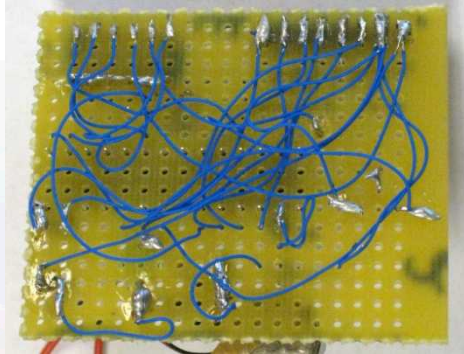
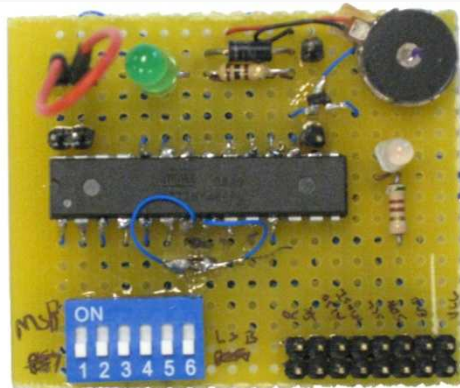


# Hardware Example

- **Problem as described by your customer:**
  - The low-voltage, constant-speed motor seems to work only some of the time.
  - On occasion, nothing seems to work on a prototype – results in scrapping the device.
  - The on-board peripheral devices (LCD driver, Real-time clock, CMOS sensor) seem to be intermittent.
- **Where do we start?**
- **What tools do we need?**
- **What information do we need from the customer?**



# Step 1) Reduce Hardware Failure Modes

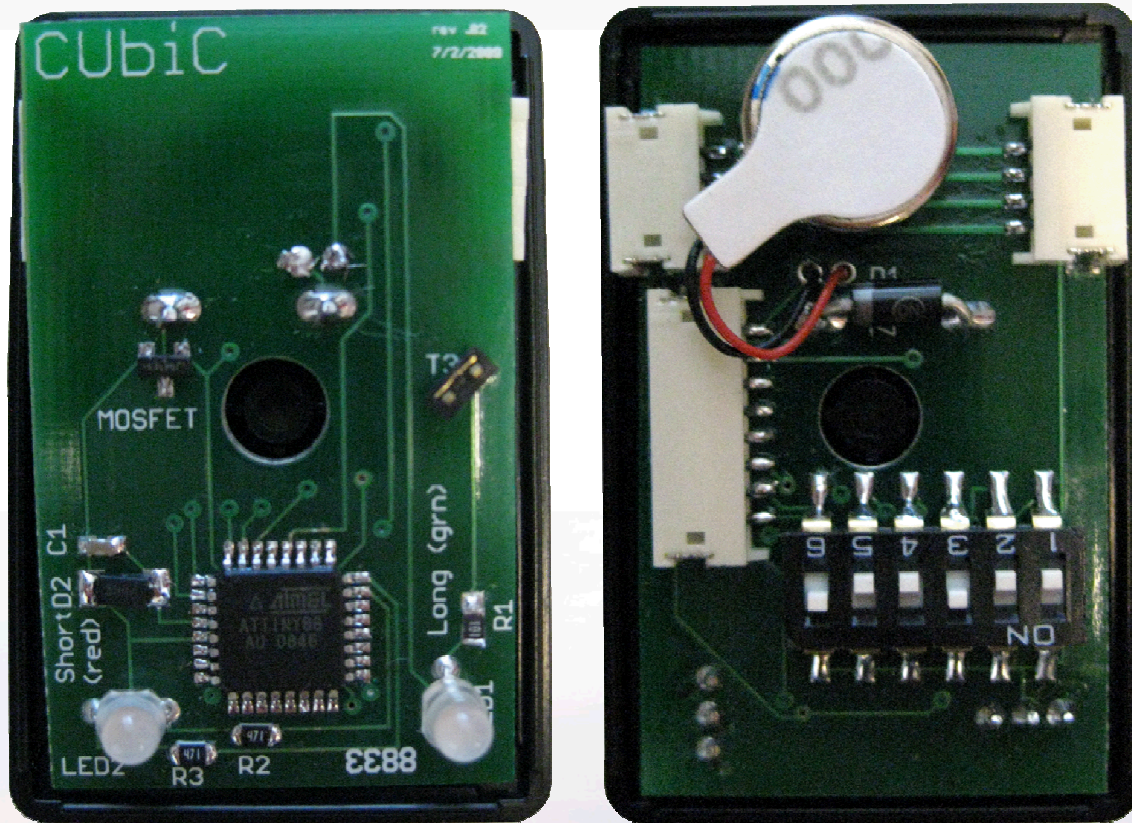


Pictures from [http://code.google.com/p/haptic-research-group/source/browse/#svn/trunk/wireless\\_haptic\\_belt/docs](http://code.google.com/p/haptic-research-group/source/browse/#svn/trunk/wireless_haptic_belt/docs)

## Lets identify possible modes of failure.....



# Step 1) Reduce Hardware Failure Modes



Pictures from [http://code.google.com/p/haptic-research-group/source/browse/#svn/trunk/wireless\\_haptic\\_belt/docs](http://code.google.com/p/haptic-research-group/source/browse/#svn/trunk/wireless_haptic_belt/docs)

## Lets identify possible modes of failure.....





# Step 1) Reduce Hardware Failure Modes

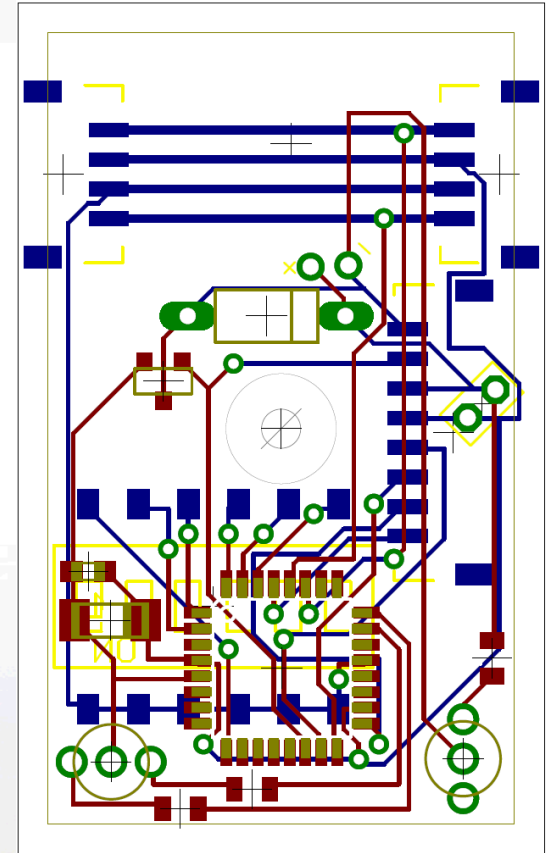
- **Possible modes of failure:**

- Loose connections
- Solder bridges
- Conflicting sub-system voltages
- Power supply noise
- EMI
- Energy storage devices
- System clock sources
- PCB layout and trace clearances (especially multilayer boards).
- Other...



# Step 1) Reduce Hardware Failure Modes

- **Verify conductance of traces:**
  - Start at end points and work your way in.
  - Visual inspection may also be needed.
- **Verify all GND connections:**
  - Are there multiple grounding planes?
  - Are they connected or EM isolated?



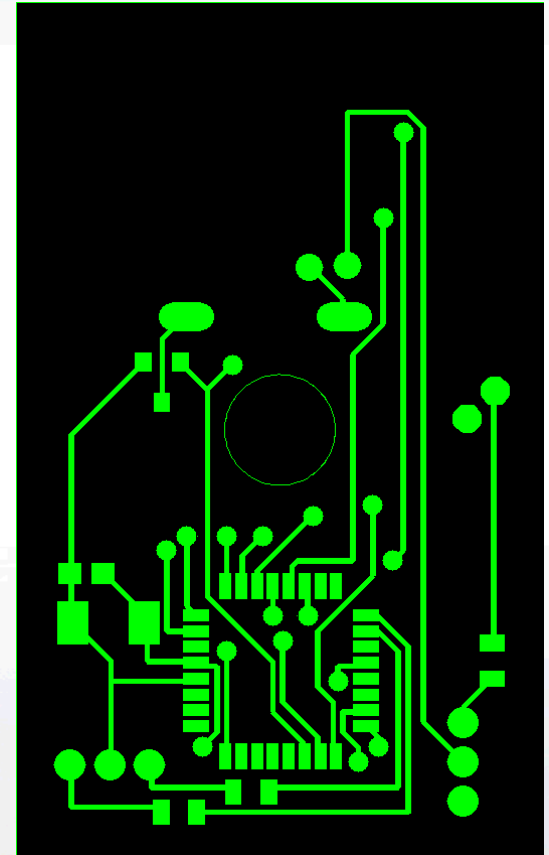
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# Step 1) Reduce Hardware Failure Modes

- **Verify conductance of traces:**
  - Start at end points and work your way in.
  - Visual inspection may also be needed.
- **Verify all GND connections:**
  - Are there multiple grounding planes?
  - Are they connected or EM isolated?
- **Analyze analog components:**
  - Identify the types and ratings of each component (find datasheets).
  - Look at the configuration – is the polarity correct?



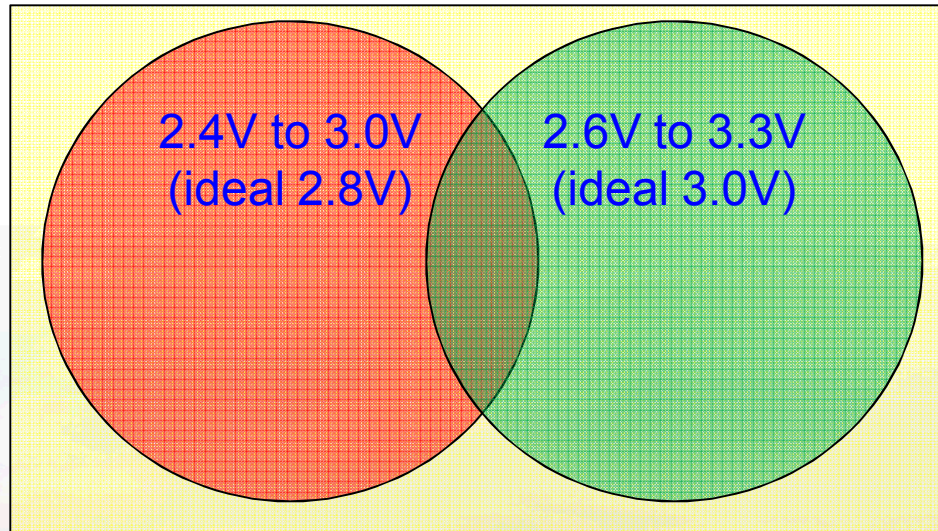
Picture from [http://code.google.com/p/haptic-research-group/source/browse/#svn/trunk/wireless\\_haptic\\_belt/docs](http://code.google.com/p/haptic-research-group/source/browse/#svn/trunk/wireless_haptic_belt/docs)



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# Step 1) Reduce Hardware Failure Modes

- **Analyze System and Sub-system voltage requirements:**
  - Need to identify chips & components and find datasheets.
  - Can all devices be sourced from one power supply with regard to voltage and current draw?



- Is there another solution that will improve the power management and avoid brown-out conditions between devices?



# Step 1) Reduce Hardware Failure Modes

- **Analyze system clock sources:**

- What type of clock sources are used? MEMS oscillators? Crystal oscillators? Internally configured digital clocks?
- Are the source clock speeds sufficient for all sub-systems?
- Is the clock source subject to signal degradation when connected to multiple devices?

- **Analyze energy storage devices:**

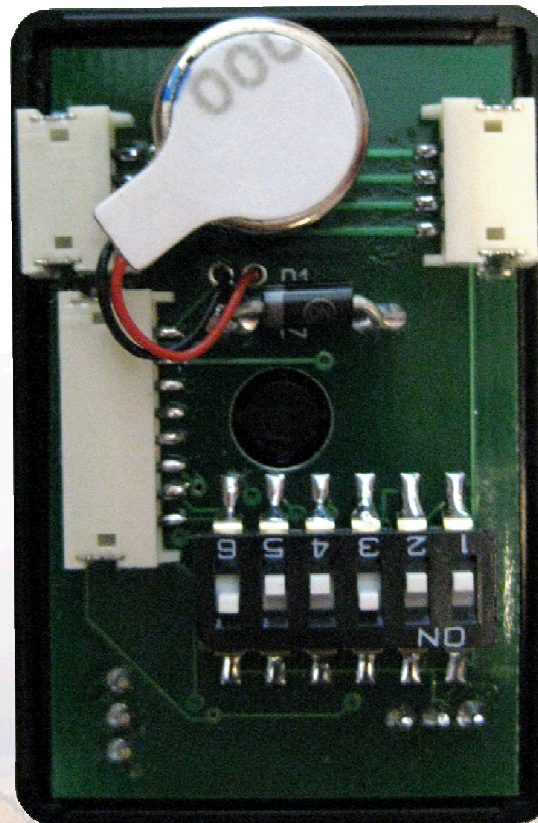
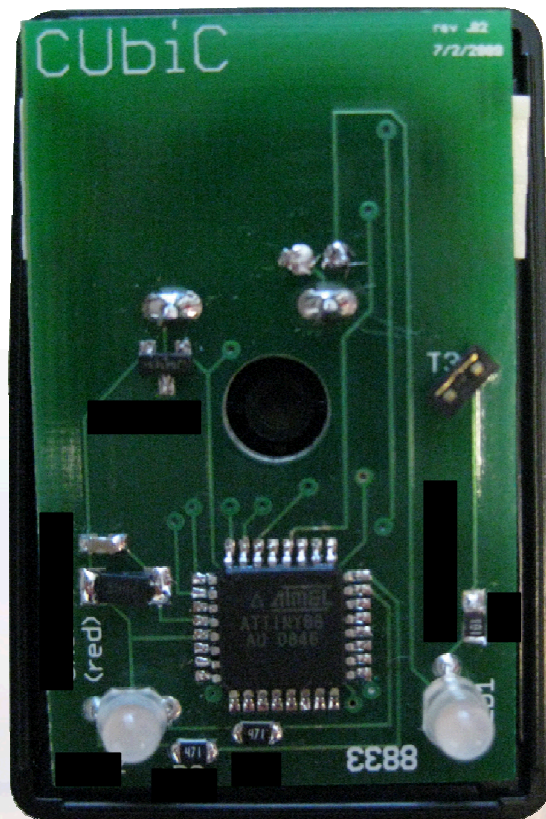
- Identify all the potential storage devices.
- Identify the types and ratings of each component.
- Look at the configuration – is the polarity correct? Is there a conflict in current or voltage maximums?
- What are the storage or discharge characteristics of each?

(hint – you may need to bench test the component for more data)



# Step 1) Reduce Hardware Failure Modes

**EXERCISE:** Identify the components.....



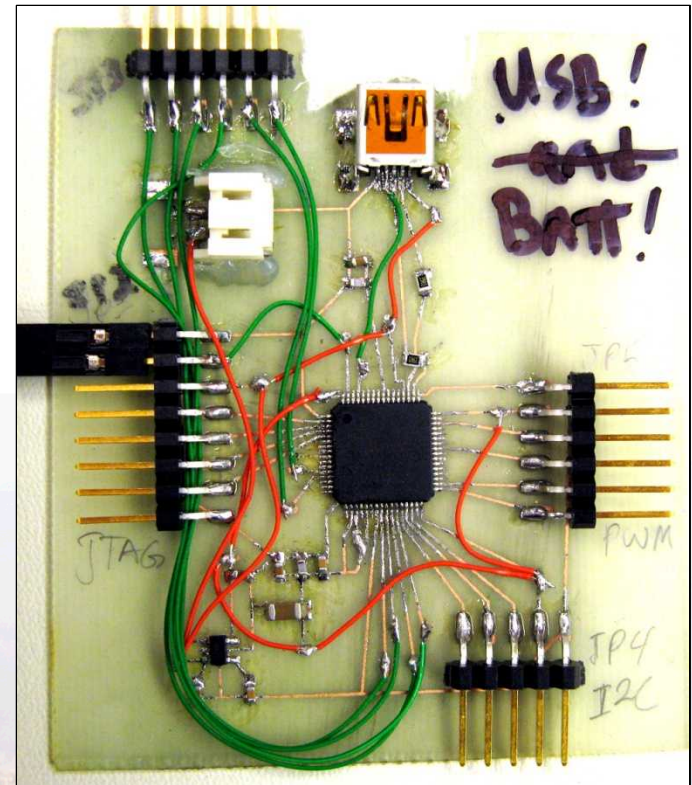
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## Step 2) Make Sure You Can Test the Device

- **Test interfaces must be part of the design:**
  - How will you ever know if the system is truly working at all levels?
- **What are possible test interfaces?**
  - Test pins or pads.
  - Joint Test Action Group (JTAG) interface.
  - LED or other visual indicators.
  - Serial outputs.
- **ANOTHER HARDWARE EXAMPLE...**



Picture from [http://code.google.com/p/haptic-research-group/source/browse/#svn/trunk/wireless\\_hapti\\_c\\_network/docs](http://code.google.com/p/haptic-research-group/source/browse/#svn/trunk/wireless_hapti_c_network/docs)



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# Step 3) Plan for Access to Digital Interfaces

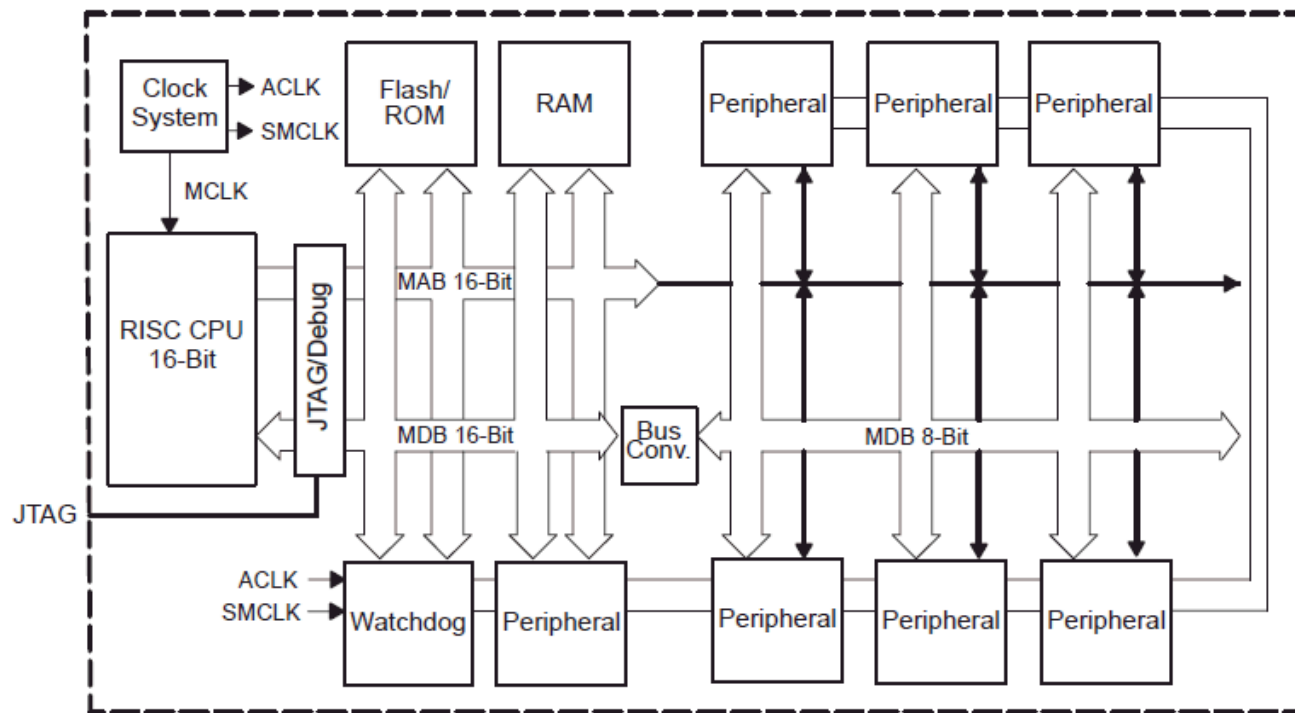
- **Monitor bus control messages:**
  - With an external device or logic analyzer you can monitor all communication bus messages – (SPI, I2C, SMBus, 1-Wire, 2-Wire)
  - Can also inject bus messages to test and verify control message sequencing.
- **Download current state of memory (SRAM and Flash ROM):**
  - Some architectures allow this, some do not.
  - May need to write software to perform memory dump.
- **Software (firmware) debugging:**
  - Can control the execution clock and code that allows you to step through each line of software code while operating directly on the hardware.



# Step 3) Plan for Access to Digital Interfaces

- The power of a JTAG Interface:

Figure 1-1. MSP430 Architecture





# Hardware Analysis for Embedded Systems

## Summary of Steps:

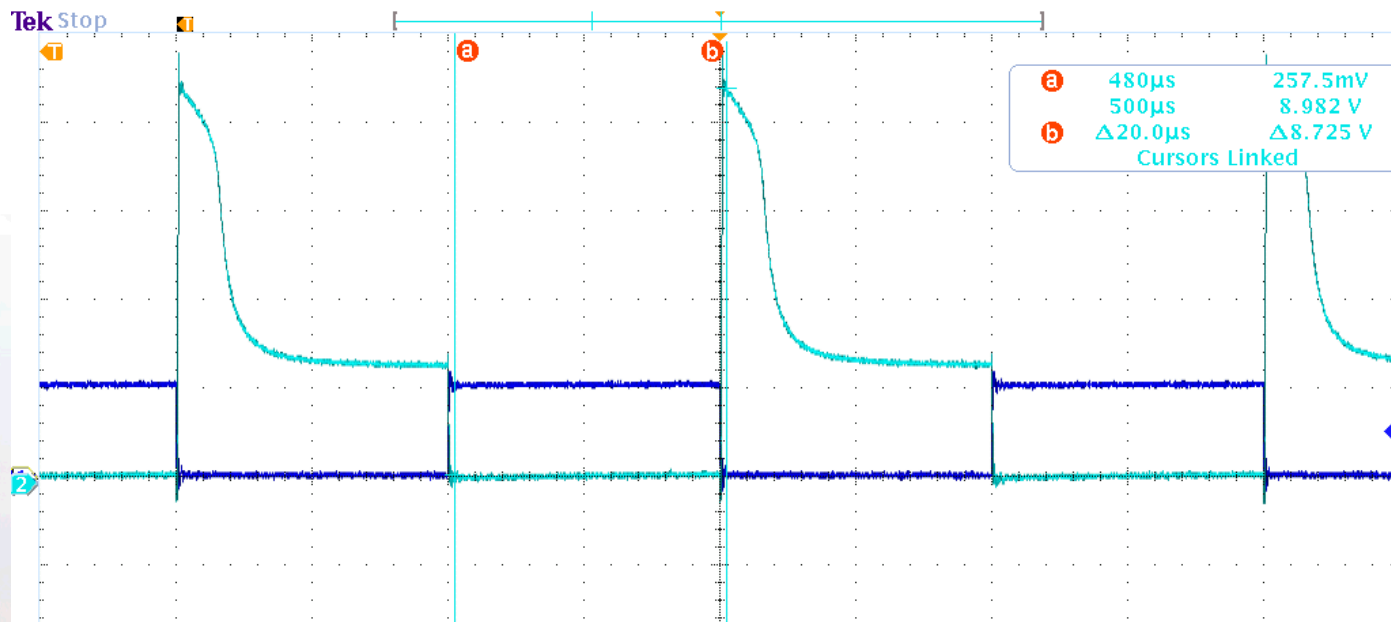
- 1) Reduce hardware failure modes.
- 2) Make sure you can test the device.
- 3) Plan for access to digital interfaces.

**If you systematically go through these steps you will find.....**



# Embedded System Hardware Analysis Results

- The constant-speed motor is causing transient issues:
  - Inductive load stores energy when turned off.
  - Resulting power spikes exceed the CMOS devices range and cause permanent damage.



**8.982V peak from Back EMF during motor off**



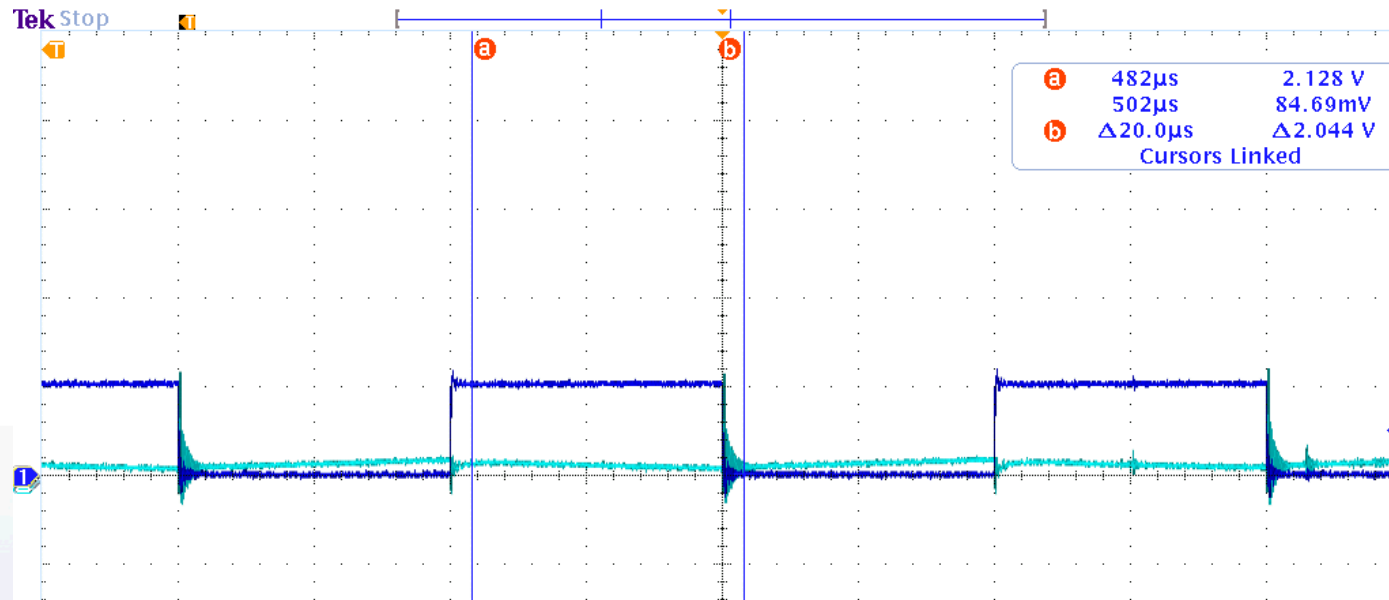
Picture from [http://code.google.com/p/haptic-research-group/source/browse/#svn/trunk/wireless\\_haptic\\_belt/docs](http://code.google.com/p/haptic-research-group/source/browse/#svn/trunk/wireless_haptic_belt/docs)



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# Embedded System Hardware Analysis Results

## ○ Solution Ideas???



- 1) Capacitor effectively suppresses Back EMF.
- 2) Is this a workable solution for the system requirements?



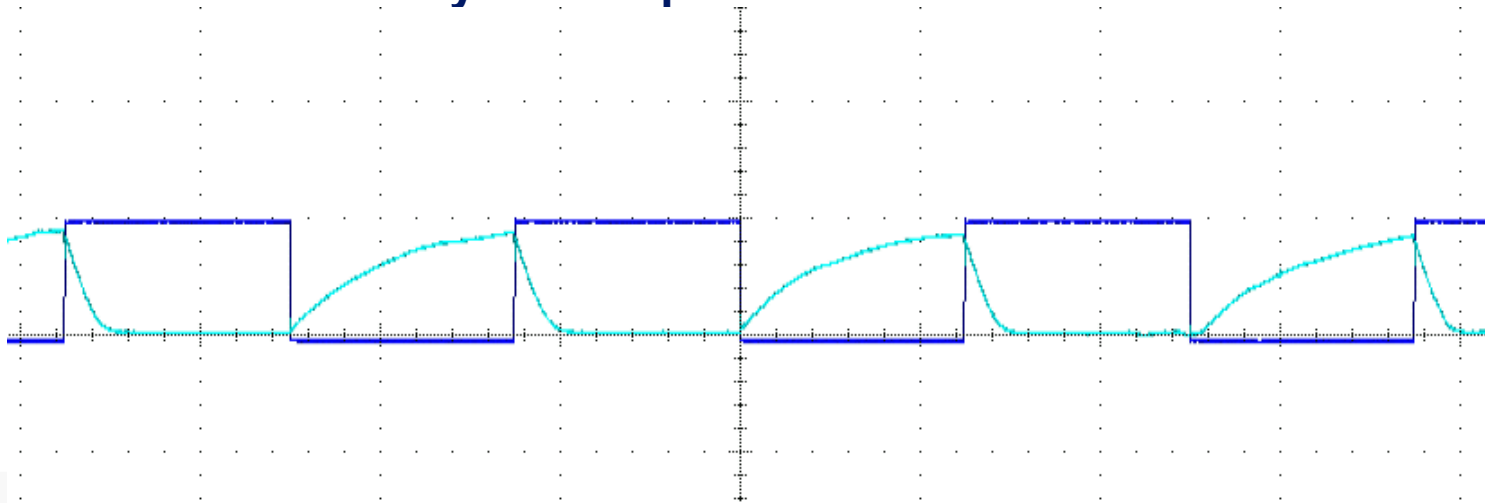
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# Embedded System Hardware Analysis Results

- Solution Ideas – Flyback Capacitor



- 1) At 25kHz capacitor is constantly powering motor (not enough time to discharge).
- 2) At 1kHz capacitor has enough time to discharge.

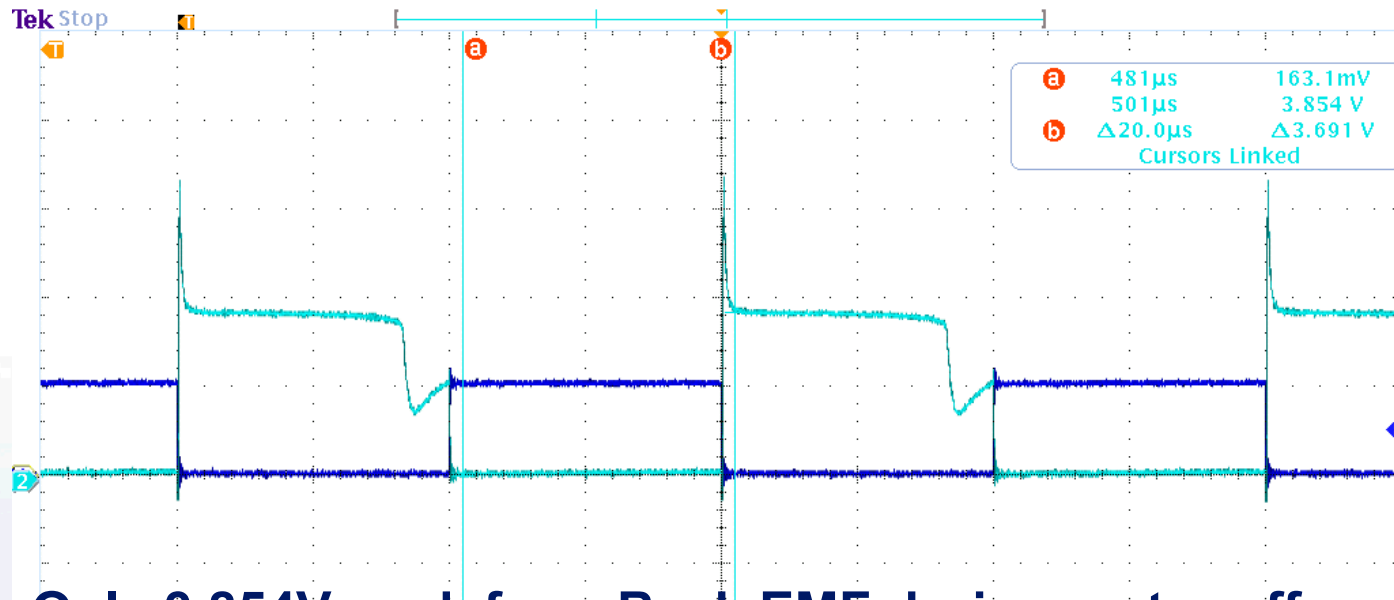
**Is this a workable solution for the system requirements?**



# Embedded System Hardware Analysis Results

## ○ Real Solutions:

- Install a 1N4001 voltage regulator diode across the contacts of the motor.



**Only 3.854V peak from Back EMF during motor off**

- Use a MOSFET that has inductive load protection built into its package.
- Although power isolation is best, sometimes the compromise of solutions is to protect the CMOS devices with bypass capacitors and zener diodes.



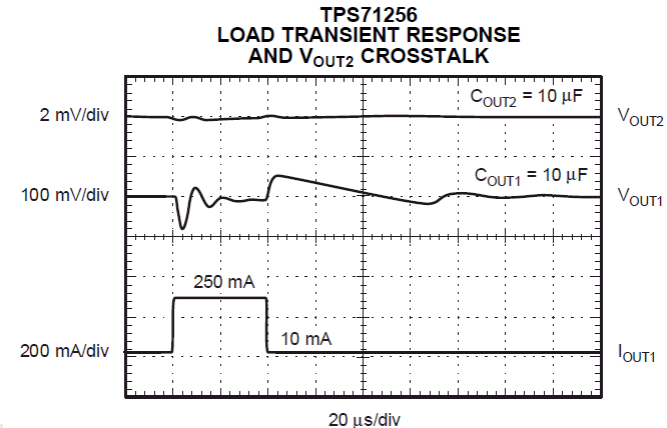
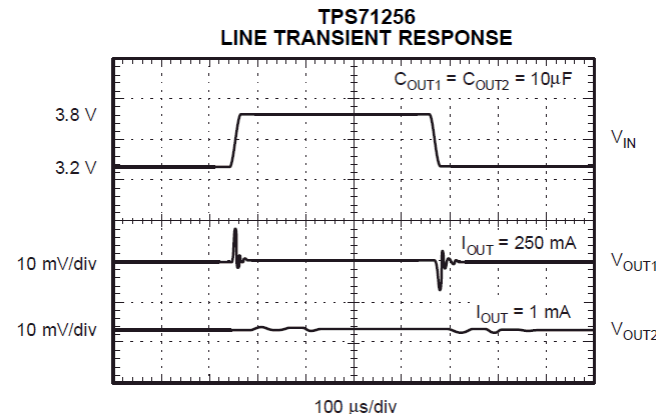
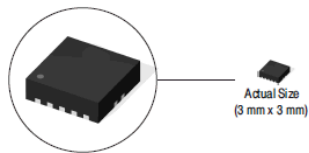
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# Embedded System Hardware Analysis Results

- **Brown-outs are caused by poor power management:**
  - When the MCU is performing a data write operation to external memory, the power draw is too much for the CMOS sensor (voltage drops below its operational threshold).
- **Solutions:**
  - Use a 2-channel, low-noise ULDO voltage regulator to supply the different voltages.



- Make sure to select one that is rated for the system's current (Amps) requirements.

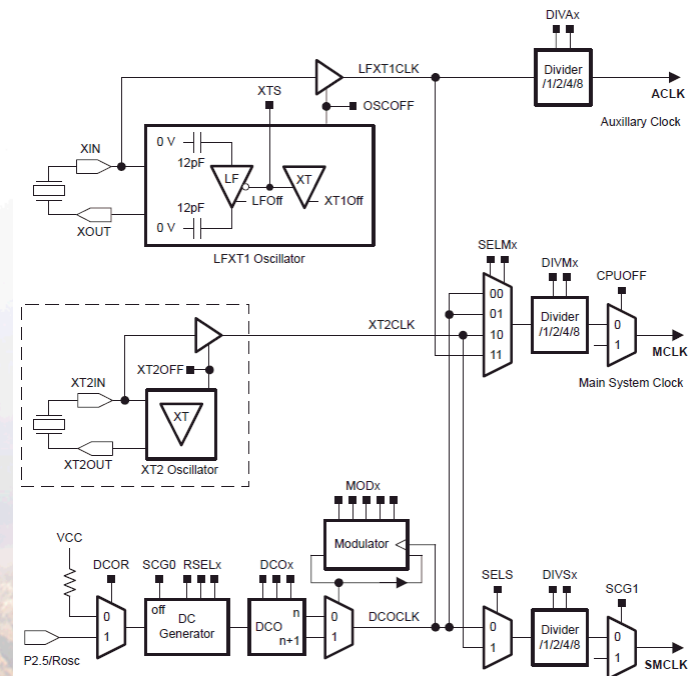


# Embedded System Hardware Analysis Results

- **Intermittent data bus issues caused by system clock configuration:**
  - Discovered an errata sheet for the MCU - the clock divider for the data bus clock can only handle a system clock of  $< 1$  MHz.
  - Same errata sheet states that there is a timing conflict with the software execution when an interrupt occurs at the same time as writing the data bus output buffer.

- **Solutions:**

- Coordinate system wide clock speeds, maybe even have 2 or more clock sources.
- Compensate for the errata with software changes (this can be tedious, but necessary).





# Summary of Steps for Hardware Analysis

---

- 1) Reduce hardware failure modes.
- 2) Make sure you can test the device.
- 3) Plan for access to digital interfaces.

**Systematically follow the above steps  
using good science and documentation.**

**Thank you and stay tuned for  
recruiting information.....**





# References

- [1] Pictures from [http://code.google.com/p/haptic-research-group/source/browse/#svn/trunk/wireless\\_haptic\\_belt/docs](http://code.google.com/p/haptic-research-group/source/browse/#svn/trunk/wireless_haptic_belt/docs).
- [2] Texas Instruments MSP430x1xx Family User Guide SLAU049F.pdf available at <http://www.ti.com/>
- [3] Texas Instruments datasheet for Dual 250 mA Output, UltraLow Noise, High PSRR, Low-Dropout Linear Regulator SBVS049C.pdf available at <http://www.ti.com/>

